Hex Schmitt Trigger

The MC14106B hex Schmitt Trigger is constructed with MOS P-channel and N-channel enhancement mode devices in a single monolithic structure. These devices find primary use where low power dissipation and/or high noise immunity is desired. The MC14106B may be used in place of the MC14069UB hex inverter for enhanced noise immunity or to "square up" slowly changing waveforms.

This device contains protection circuitry to guard against damage due to high static voltages or electric fields. However, precautions must be taken to avoid applications of any voltage higher than maximum rated voltages to this high–impedance circuit. For proper operation, V_{in} and V_{out} should be constrained to the range $V_{SS} \leq (V_{in} \text{ or } V_{out}) \leq V_{DD}$.

Unused inputs must always be tied to an appropriate logic voltage level (e.g., either V_{SS} or V_{DD}). Unused outputs must be left open.

Features

- Increased Hysteresis Voltage Over the MC14584B
- Supply Voltage Range = 3.0 Vdc to 18 Vdc
- Capable of Driving Two Low–power TTL Loads or One Low–power Schottky TTL Load Over the Rated Temperature Range
- Pin-for-Pin Replacement for CD40106B and MM74C14
- Can Be Used to Replace the MC14584B or MC14069UB
- NLV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC–Q100 Qualified and PPAP Capable
- These Devices are Pb-Free and are RoHS Compliant

MAXIMUM RATINGS (Voltages Referenced to V_{SS})

V _{DD} DC Supply Voltage Range -0.5 to +18.0 V _{in} , V _{out} Input or Output Voltage Range (DC or Transient) -0.5 to V _{DD} + 0.5 I _{in} , I _{out} Input or Output Current (DC or Transient) per Pin ±10 P _D Power Dissipation, per Package 500	Unit
V _{in} , V _{out} Input or Output Voltage Range (DC or Transient) -0.5 to V _{DD} + 0.5 I _{in} , I _{out} Input or Output Current (DC or Transient) per Pin ±10 P _D Power Dissipation, per Package 500	Unit
(DC or Transient) I _{in} , I _{out} Input or Output Current (DC or Transient) per Pin P _D Power Dissipation, per Package	V
IDD out (DC or Transient) per Pin PD Power Dissipation, per Package 500	V
	mA
(Note 1)	mW
T _A Ambient Temperature Range -55 to +125	°C
T _{stg} Storage Temperature Range -65 to +150	°C
TL Lead Temperature 260 (8-Second Soldering) 260	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Temperature Derating: "D/DW" Packages: -7.0 mW/°C From 65°C To 125°C



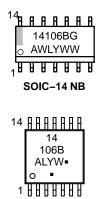
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SOIC-14 NB D SUFFIX CASE 751A TSSOP-14 DT SUFFIX CASE 948G

MARKING DIAGRAMS



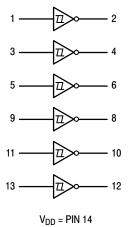
TSSOP-14

A = Assembly Location WL, L = Wafer Lot YY, Y = Year WW, W = Work Week G or • = Pb-Free Package

(Note: Microdot may be in either location)

ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 2 of this data sheet.



V_{SS} = PIN 7



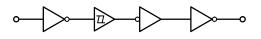


Figure 2. Equivalent Circuit Schematic (1/6 of Circuit Shown)

ORDERING INFORMATION

Device	Package	Shipping [†]		
MC14106BDG	SOIC-14 NB (Pb-Free)	55 Units / Rail		
NLV14106BDG*	SBDG* SOIC-14 NB (Pb-Free)			
MC14106BDR2G	SOIC-14 NB (Pb-Free)	2500 / Tape & Reel		
NLV14106BDR2G*	SOIC-14 NB (Pb-Free)	2500 / Tape & Reel		
MC14106BDTR2G	TSSOP-14 (Pb-Free)	2500 / Tape & Reel		
NLV14106BDTR2G*	TSSOP-14 (Pb-Free)	2500 / Tape & Reel		

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D. *NLV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC–Q100 Qualified and PPAP

Capable.

ELECTRICAL CHARACTERISTICS	(Voltages Referenced to V _{SS})
-----------------------------------	---

		–55°C 25			25°C 125°			°C			
Characteristic		Symbol	V _{DD} Vdc	Min	Мах	Min	Typ (Note 2)	Мах	Min	Max	Unit
Output Voltage V _{in} = V _{DD}	"0" Level	V _{OL}	5.0 10 15	- - -	0.05 0.05 0.05	- - -	0 0 0	0.05 0.05 0.05	- - -	0.05 0.05 0.05	Vdc
V _{in} = 0	"1" Level	V _{OH}	5.0 10 15	4.95 9.95 14.95	- - -	4.95 9.95 14.95	5.0 10 15	- - -	4.95 9.95 14.95	- - -	Vdc
Hysteresis Voltage		V _H ⁽⁵⁾	5.0 10 15	0.3 1.2 1.6	2.0 3.4 5.0	0.3 1.2 1.6	1.1 1.7 2.1	2.0 3.4 5.0	0.3 1.2 1.6	2.0 3.4 5.0	Vdc
Threshold Voltage Positive–Going		V _{T+}	5.0 10 15	2.2 4.6 6.8	3.6 7.1 10.8	2.2 4.6 6.8	2.9 5.9 8.8	3.6 7.1 10.8	2.2 4.6 6.8	3.6 7.1 10.8	Vdc
Negative-Going		V _{T-}	5.0 10 15	0.9 2.5 4.0	2.8 5.2 7.4	0.9 2.5 4.0	1.9 3.9 5.8	2.8 5.2 7.4	0.9 2.5 4.0	2.8 5.2 7.4	Vdc
$\begin{array}{l} \text{Output Drive Current} \\ (V_{OH} = 2.5 \ \text{Vdc}) \\ (V_{OH} = 4.6 \ \text{Vdc}) \\ (V_{OH} = 9.5 \ \text{Vdc}) \\ (V_{OH} = 13.5 \ \text{Vdc}) \end{array}$	Source	I _{OH}	5.0 5.0 10 15	-3.0 -0.64 -1.6 -4.2	- - -	-2.4 -0.51 -1.3 -3.4	-4.2 -0.88 -2.25 -8.8	- - -	-1.7 -0.36 -0.9 -2.4		mAdo
(V _{OL} = 0.4 Vdc) (V _{OL} = 0.5 Vdc) (V _{OL} = 1.5 Vdc)	Sink	I _{OL}	5.0 10 15	0.64 1.6 4.2	- - -	0.51 1.3 3.4	0.88 2.25 8.8	- - -	0.36 0.9 2.4	- - -	mAdo
Input Current		l _{in}	15	-	±0.1	-	±0.00001	±0.1	-	±1.0	μAdc
Input Capacitance (V _{in} = 0)		C _{in}	-	-	-	-	5.0	7.5	-	-	pF
Quiescent Current (Per Package)		I _{DD}	5.0 10 15	- - -	0.25 0.5 1.0	- - -	0.0005 0.0010 0.0015	0.25 0.5 1.0	_ _ _	7.5 15 30	μAdc
Total Supply Current (Notes (Dynamic plus Quiescer Per Package) $(C_L = 50 \text{ pF on all outpu}$ buffers switching)	nt,	ŀτ	5.0 10 15	$I_{T} = (1.8 \ \mu A/kHz) \ f + I_{DD}$ $I_{T} = (3.6 \ \mu A/kHz) \ f + I_{DD}$ $I_{T} = (5.4 \ \mu A/kHz) \ f + I_{DD}$			μAdc				

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 2. Data labelled "Typ" is not to be used for design purposes but is intended as an indication of the IC's potential performance.

3. The formulas given are for the typical characteristics only at 25°C.

4. To calculate total supply current at loads other than 50 pF: $I_T(C_L) = I_T(50 \text{ pF}) + (C_L - 50) \text{ Vfk where } I_T \text{ is in } \mu\text{A} \text{ (per package), } C_L \text{ in pF, } V = (V_{DD} - V_{SS}) \text{ in volts, f in kHz is input frequency, and}$ k = 0.001.

5. $V_H = V_{T+} - V_{T-}$ (But maximum variation of V_H is specified as less that $V_{T+max} - V_{T-min}$).

SWITCHING CHARACTERISTICS (CL = 50 pF, TA = 25° C)

Characteristic	Symbol	V _{DD} Vdc	Min	Typ (Note 6)	Max	Unit
Output Rise Time	t _{TLH}	5.0 10 15	- - -	100 50 40	200 100 80	ns
Output Fall Time	t _{THL}	5.0 10 15		100 50 40	200 100 80	ns
Propagation Delay Time	t _{PLH} , t _{PHL}	5.0 10 15	- - -	125 50 40	250 100 80	ns

6. Data labelled "Typ" is not to be used for design purposes but is intended as an indication of the IC's potential performance.

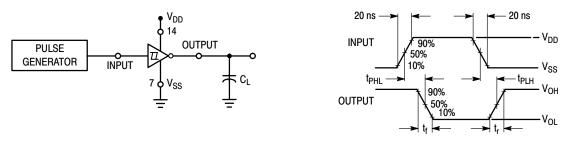


Figure 1. Switching Time Test Circuit and Waveforms

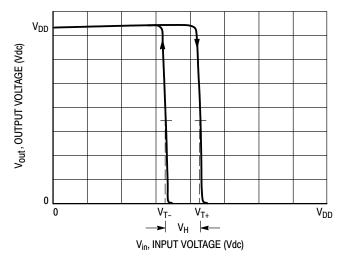
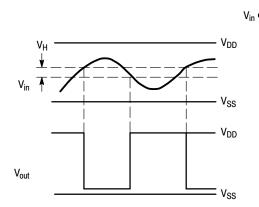
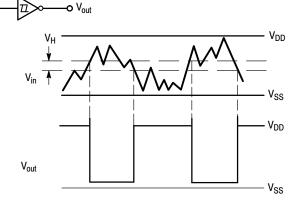


Figure 2. Typical Transfer Characteristics

APPLICATIONS

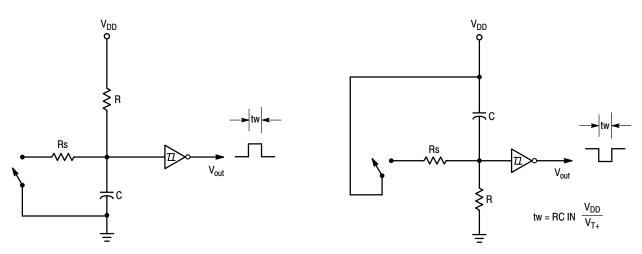




(a) Schmitt Triggers will square up inputs with slow rise and fall times.

(b) A Schmitt trigger offers maximum noise immunity in gate applications.





Useful as Pushbutton/Keyboard Debounce Circuit.

Figure 4. Monostable Multivibrator

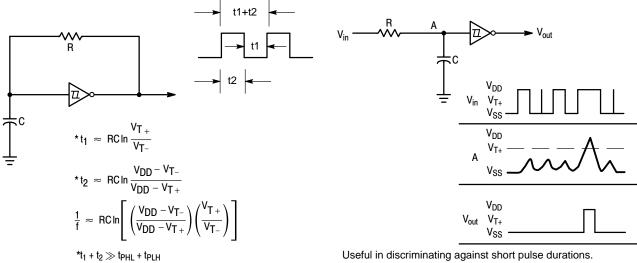
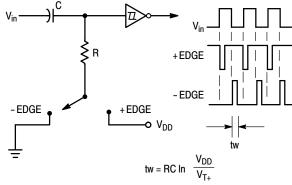


Figure 5. Astable Multivibrator

Useful in discriminating against short pulse durations.

Figure 6. Integrator



Useful as an edge detector circuit.

Figure 7. Differentiator

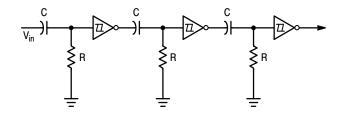
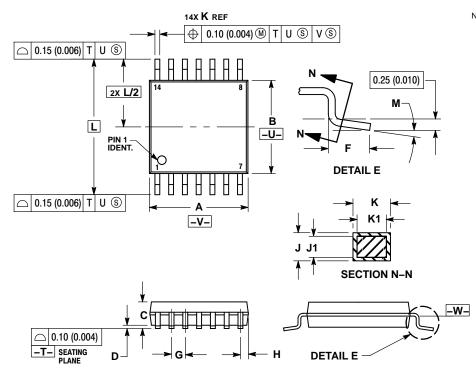


Figure 8. Positive Edge Time Delay Circuit

PACKAGE DIMENSIONS

TSSOP-14 CASE 948G **ISSUE B**

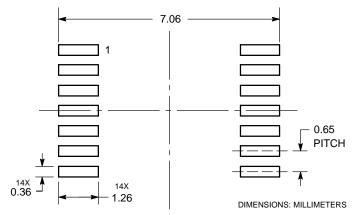


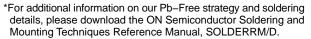
NOTES:

- DIES:
 DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 CONTROLLING DIMENSION: MILLIMETER.
 DIMENSION A DOES NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS. MOLD FLASH OR GATE BURRS SHALL NOT EVOLUTION OF DOED OF DOING SHALL NOT
- EXCEED 0.15 (0.006) PER SIDE. 4. DIMENSION B DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSION. INTERLEAD FLASH OR PROTRUSION SHALL
- NOT EXCEED 0.25 (0.010) PER SIDE. 5. DIMENSION K DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08 (0.003) TOTAL IN EXCESS OF THE K DIMENSION AT MAXIMUM MATERIAL CONDITION
- CONDITION. 6. TERMINAL NUMBERS ARE SHOWN FOR REFERENCE ONLY.
- 7. DIMENSION A AND B ARE TO BE DETERMINED AT DATUM PLANE -W-.

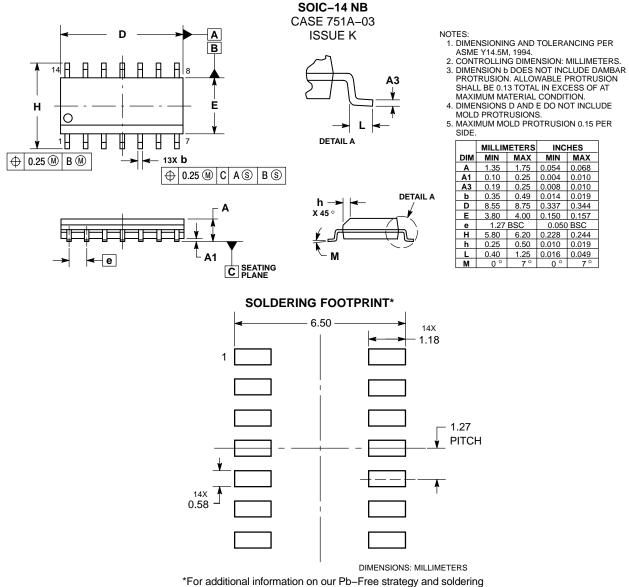
	MILLIN	IETERS	INCHES		
DIM	MIN	MAX	MIN	MAX	
Α	4.90	5.10	0.193	0.200	
В	4.30	4.50	0.169	0.177	
С		1.20		0.047	
D	0.05	0.15	0.002	0.006	
F	0.50	0.75	0.020	0.030	
G	0.65	BSC	0.026 BSC		
Н	0.50	0.60	0.020	0.024	
J	0.09	0.20	0.004	0.008	
J1	0.09	0.16	0.004	0.006	
κ	0.19	0.30	0.007	0.012	
K1	0.19	0.25	0.007	0.010	
Г	6.40		0.252 BSC		
Μ	0 °	0° 8°		8 °	

SOLDERING FOOTPRINT*





PACKAGE DIMENSIONS



For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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